

## **Final Product Change Notification**

Issue Date:24-May-2018Effective Date:22-Aug-2018

## 201804013F01



## **Management Summary**

NXP Semiconductors announces the MC9S08AWXX 0N20A maskset update to 1N20A for OSC drive current increase and ICG fix.

## **Change Category**

Wafer Fab	Assembly	Product Marking	Test	V	Design
Process	Process		Location		
Wafer Fab Materials	Assembly Materials	Mechanical Specification	Test Proces	s	Errata
Wafer Fab	Assembly Location	C Packing/Shipping/Labeling	Test Equipment		Electrical spec./Test
Firmware	Other		- 45.Fo.u	201	

# MC9S08AWXX TSMC3 Maskset Update to 1N20A for Design Fix

## **Description of Change**

NXP Semiconductors is announcing a new version of silicon for the MC9S08AWXX 0N20A product line. The new silicon mask revision will be 1N20A.

An errata document is generated for the MC9S08AW60/48/32/16 Mask 1N20A devices associated with this notification. The document provides a detailed description of the changes, along with existing deviations from datasheet identified on current production devices. Potential implications on customer applications are described.

## 1N20A:

The following erratum was removed. SE194-STOP3DCO: Stop3 Mode DCO Erratum. The following erratum was added. SE198B-ICG-RANGE=0, HGO=1: Oscillator Mode Erratum.

The errata MSE9S08AW60\_1N20A revision 0 can be found at: http://www.nxp.com/products/automotive-products/microcontrollers-and-processors/arm-mcus-and-mpus/s32arm-processors-microcontrollers/8-bit-general-purpose-aw60-48-32-16-mcus:S08AW?tab=Documentation\_Tab

## **Reason for Change**

The release of MC9S08AWXX 1N20A maskset fixes Erratum SE194-STOP3DCO: Stop3 Mode DCO.

## **Identification of Affected Products**

Top side marking The maskset information in the marking will be changed from 0N20A to 1N20A.

## **Product Availability**

#### **Sample Information**

Samples are available from 26-Apr-2018 Part number is PC9S08AW60MFUE

## Production

Planned first shipment 24-Jul-2018

## Anticipated Impact on Form, Fit, Function, Reliability or Quality

There is no change to product form, fit, function, or reliability, for the new identified errata, there are potential hardware and / or software implications to customers.

## **Data Sheet Revision**

No impact to existing datasheet

## **Disposition of Old Products**

Existing inventory will be shipped until depleted

## **Additional information**

Self qualification: <u>view online</u> Additional documents: <u>view online</u>

#### **Timing and Logistics**

In compliance with JEDEC J-STD-046, your acknowledgement of this change is expected by 23-Jun-2018.

## **Contact and Support**

For all inquiries regarding the ePCN tool application or access issues, please <u>contact NXP "Global Quality</u> <u>Support Team"</u>.

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

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At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards. Customer Focus, Passion to Win.

NXP Quality Management Team.

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